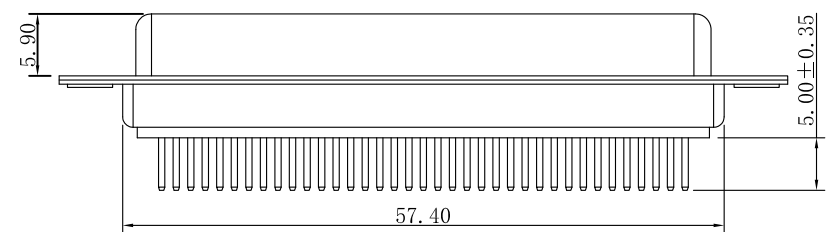
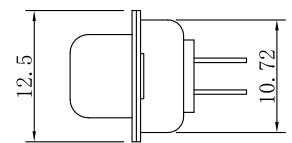
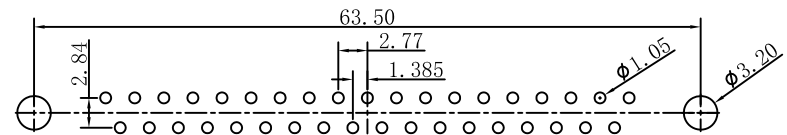


The product using material and processing must conform to the "WI-PZ-001"HSF technical standard control requirements



CHARACTERISTICS:

- 1、 RATED VOLTAGE: 250V AC CD
- 2、 RATED CURRENT: 3.0AMP
- 3、 CONTACT RESISTANCE: 30mΩ Max.
- 4、 INSULATION RESISTANCE: 1000 MΩ MIN.500V DC
- 5、 Electric Pressure: Keeping 60 second in AC 500V/1mA
- 6、 Operating temperature: -55℃~105℃
- 7、 INSERTION/EXTRACTION FORCE PER CONTACT: 12.5Kg Max
1.1Kg Min.



PCB layout

Specification Type			
A	B	C	D
	6.00	4.80	5.80

ORDER INFORMTION

P/N: WLDBF0-371XXX032

Number of Contact:

Contact Type: 1: DIP

Plating Contact: 1: Gold Flash, 3: Au: 3U", 6: Au: 30U"

SCREW

Housing color: A: Black, S: Nature

A: Specification Type A
B: Specification Type B
C: Specification Type C
D: Specification Type D

REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART. NO:	DWG. NO:	
A0	NEW RELEASE	21.01.13		LINEAR	ANGLES	APPROVED	Wang_jr	21.03.11	WLDBF0-371XXX032	ENDE05	
			UNIT: mm	0.00±0.25	X° ±3°	DESIGNER	Ding_Bo	21.03.11	TITLE:		REV: A0 SHEET: 1/1
			SIZE: A4	0.000±0.10	X° X'±2°	DRAWN	Ou_Jian	21.03.11	DP 37F DIP		